

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|--------------|-------------|---|---|-------------------------|----------------|---------------------|
| L1 | 2760 | (mold\$3 with interface with material) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/05/06 07:53 |
| L2 | 75 | (mold\$3 with interface with material) and (discrete with layer) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/05/06 07:53 |
| L3 | 75 | 1 and 2 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/05/06 07:54 |
| L4 | 2 | (seperate with mold\$3 with compound) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/05/06 07:55 |
| L5 | 0 | 3 and 4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/05/06 07:55 |
| L6 | 5 | 1 and 2 and (semiconductor with package) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/05/06 07:55 |

5/6/2008 9:08:11 AM**C:\Documents and Settings\srao2\My Documents\EAST\Workspaces\10573789.wsp**